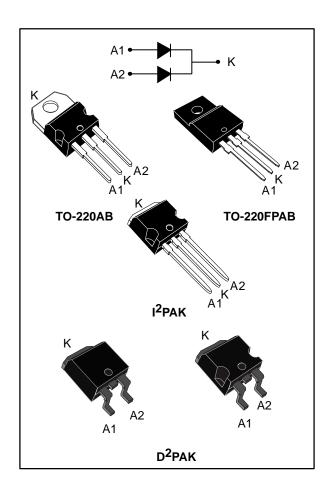




# High efficiency ultrafast diode

Datasheet - production data



#### **Features**

- Suited for SMPS
- Low losses
- Low forward and reverse recovery times
- Low leakage current
- High junction temperature
- Insulated package: TO-220FPAB
  - Insulating voltage = 2000 V<sub>RMS</sub> sine
- ECOPACK®2 compliant component for D²PAK on demand

#### **Description**

Dual center tap rectifier suited for switch mode power supplies and high frequency DC/DC converters.

Packaged in TO-220AB, TO-220FPAB, I<sup>2</sup>PAK or D<sup>2</sup>PAK, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.

**Table 1: Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	2 x 10 A
$V_{RRM}$	200 V
T <sub>j</sub> (max)	175 °C
V <sub>F</sub> (typ)	0.78 V
t <sub>rr</sub> (typ)	22 ns

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#### 1 Characteristics

Table 2: Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol		Parameter				
V <sub>RRM</sub>	Repetitive peak re	everse voltage			200	V
I <sub>F(RMS)</sub>	Forward rms curr	ent			30	Α
			T <sub>C</sub> = 150 °C	Per diode	10	
		TO-220AB,	T <sub>C</sub> = 140 °C	Per device	20	
	$I_{F(peak)}$ Average forward current $\delta = 0.5$ , square wave	D <sup>2</sup> PAK, I <sup>2</sup> PAK	T <sub>C</sub> = 130 °C	Per diode	15	А
IF(peak)			T <sub>C</sub> = 115 °C	Per device	30	
		wave	TO 0005DAD	T <sub>C</sub> = 120 °C	Per diode	10
		TO-220FPAB	T <sub>C</sub> = 85 °C	Per device	20	
IFSM	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal		90	А	
T <sub>stg</sub>	Storage temperature range			-65 to + 175	°C	
Tj	Maximum operati	ng junction tempe	rature <sup>(1)</sup>		175	°C

#### Notes:

**Table 3: Thermal parameter** 

Symbol		Parameter				
		TO-220AB, D <sup>2</sup> PAK, I <sup>2</sup> PAK	Per diode	2.5		
	R <sub>th(j-c)</sub> Junction to case	10-220AB, D-PAK, I-PAK	Per device	1.6	0 <b>0</b> AA/	
Kth(j-c)		TO 220EDAD	Per diode	5	°C/W	
		TO-220FPAB	Per device	3.8		
Б	Coupling	TO-220AB, D <sup>2</sup> PAK, I <sup>2</sup> PAK		0.7	°C AA7	
R <sub>th(c)</sub>	Coupling	TO-220FPAB	-	2.5	°C/W	

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_{j(diode1)} = P_{(diode1)} \; x \; R_{th(j-c) \; (per \; diode)} \; + \; P_{(diode2)} \; x \; R_{th(c)}$ 

 $<sup>^{(1)}(</sup>dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

STTH2002C Characteristics

Table 4: Static electrical characteristics (per diode)

	Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit		
Ī	I <sub>R</sub> <sup>(1)</sup>	(1) T <sub>j</sub> = 25 °C		-		10				
	IR <sup>(*)</sup>	Reverse leakage current $T_j = T_j$	T <sub>j</sub> = 125 °C	$V_R = V_{RRM}$	ı	6	100	μΑ		
			T 05 00	T 05 00	T 05.00	I <sub>F</sub> = 10 A	-		1.1	
	V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 20 A	-		1.25	V		
	VF(=)	Forward voltage drop	T <sub>j</sub> = 150 °C	I <sub>F</sub> = 10 A	ı	0.78	0.89	V		
				I <sub>F</sub> = 20 A	-		1.05	ļ		

#### Notes:

 $^{(1)}$ Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2%

 $^{(2)}\text{Pulse}$  test:  $t_p$  = 380  $\mu\text{s},\,\delta$  < 2%

To evaluate the conduction losses use the following equation:

 $P = 0.73 \text{ x } I_{F(AV)} + 0.020 I_{F^2(RMS)}$ 

Table 5: Dynamic electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 1 A, V <sub>R</sub> = 30 V, dI <sub>F</sub> /dt= 100 A/μs	-	22	27	ns
t <sub>fr</sub>	Forward recovery time	T <sub>j</sub> = 25 °C	$I_F = 10 \text{ A},$ $dI_F/dt = 100 \text{ A/}\mu\text{s},$ $V_{FR} = 1.1 \text{ x V}_{Fmax},$	-		200	ns
V <sub>FP</sub>	Forward recovery voltage	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A, dI <sub>F</sub> /dt = 100 A/μs	-	2.4		V
I <sub>RM</sub>	Reverse recovery current	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 10 A, V <sub>R</sub> = 160 V, dI <sub>F</sub> /dt = 200 A/µs	-	7.0	9.0	А

Characteristics STTH2002C

### 1.1 Characteristics (curves)

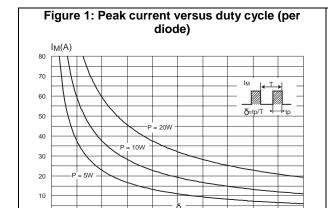


Figure 2: Forward voltage drop versus forward current (typical values, per diode)

IFM(A)

100

90

80

70

60

50

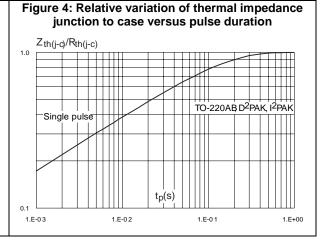
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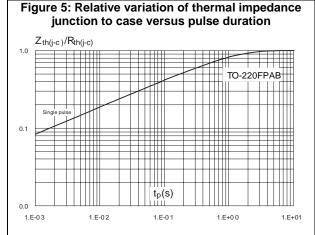
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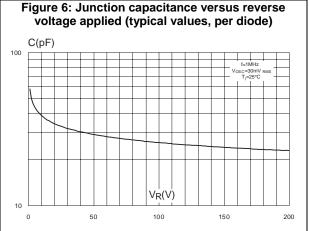
20

10

0.0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 1.6 1.8 2.0 2.2 2.4







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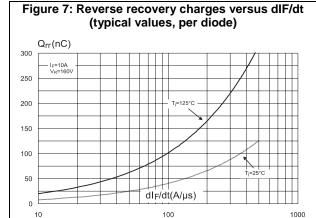
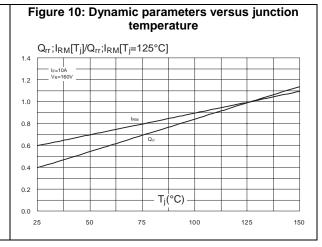
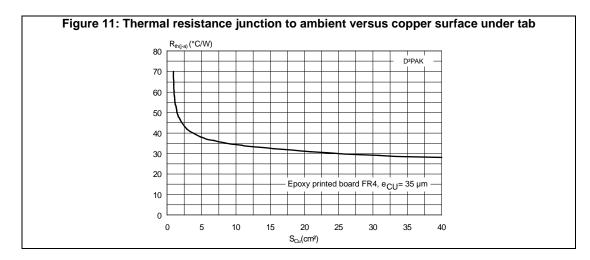


Figure 8: Reverse recovery time versus dIF/dt (typical values, per diode) t<sub>rr</sub>(ns)  $dI_F/dt(A/\mu s)$ 





Package information STTH2002C

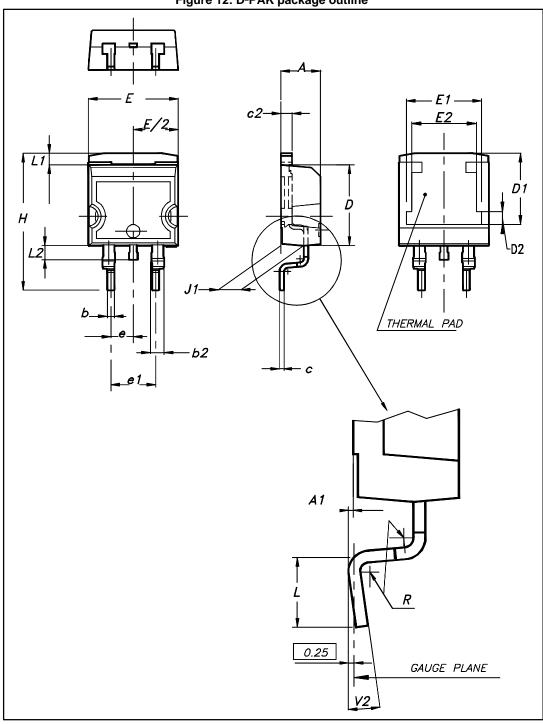
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0
- Recommended torque value: 0.55 N·m (for TO-220AB and TO-220FPAB)
- Maximum torque value: 0.7 N·m (for TO-220AB and TO-220FPAB)

## 2.1 D<sup>2</sup>PAK package information

Figure 12: D<sup>2</sup>PAK package outline

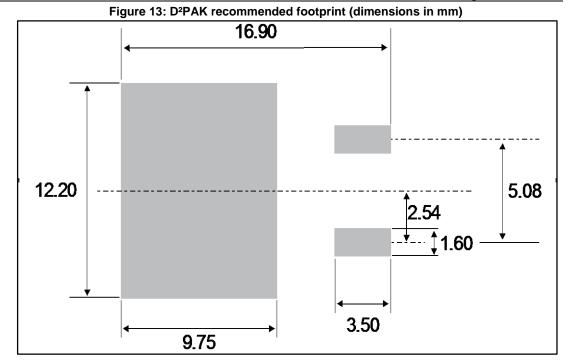




This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 6: D<sup>2</sup>PAK package mechanical data

		Dime	nsions	
Ref.	Millin	neters	Incl	hes
	Min.	Max.	Min.	Max.
А	4.36	4.60	0.172	0.181
A1	0.00	0.25	0.000	0.010
b	0.70	0.93	0.028	0.037
b2	1.14	1.70	0.045	0.067
С	0.38	0.69	0.015	0.027
c2	1.19	1.36	0.047	0.053
D	8.60	9.35	0.339	0.368
D1	6.90	8.00	0.272	0.311
D2	1.10	1.50	0.043	0.060
Е	10.00	10.55	0.394	0.415
E1	8.10	8.90	0.319	0.346
E2	6.85	7.25	0.266	0.282
е	2.54	typ.	0.100	
e1	4.88	5.28	0.190	0.205
Н	15.00	15.85	0.591	0.624
J1	2.49	2.90	0.097	0.112
L	1.90	2.79	0.075	0.110
L1	1.27	1.65	0.049	0.065
L2	1.30	1.78	0.050	0.070
R	0.4	typ.	0.0	15
V2	0°	8°	0°	8°



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## 2.2 I<sup>2</sup>PAK package information

Figure 14: I<sup>2</sup>PAK package outline

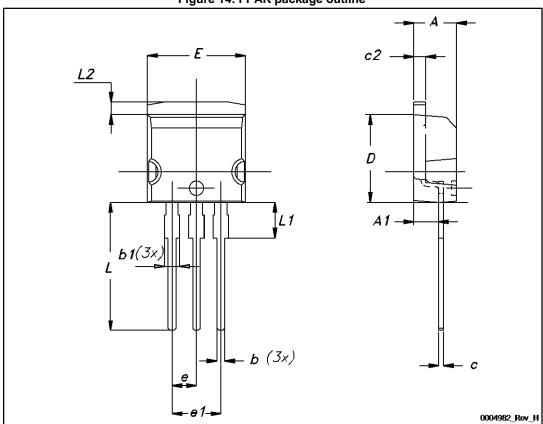


Table 7: I<sup>2</sup>PAK package mechanical data

Dim.	mm				
Dim.	Min.	Тур.	Max.		
А	4.40	_	4.60		
A1	2.40	_	2.72		
b	0.61	_	0.88		
b1	1.14	_	1.70		
С	0.49	_	0.70		
c2	1.23	_	1.32		
D	8.95	_	9.35		
е	2.40	_	2.70		
e1	4.95	_	5.15		
Е	10	_	10.40		
L	13	_	14		
L1	3.50	_	3.93		
L2	1.27	_	1.40		

Mounting (soldering) the  $I^2PAK$  metal slug (heatsink) with alloy, like a surface mount device, IS NOT PERMITTED. A standard through-hole mounting is mandatory.

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## 2.3 TO-220AB type A (DZ) package information

Figure 15: TO-220AB package outline

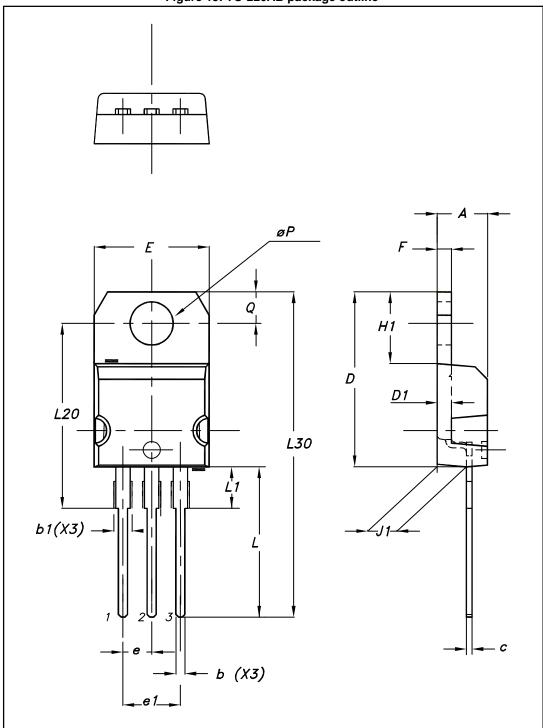


Table 8: TO-220AB package mechanical data

		Dime	ensions	
Ref.	Millim	neters	Inc	hes
	Min.	Max.	Min.	Max.
Α	4.40	4.60	0.173	0.181
b	0.61	0.88	0.24	0.035
b1	1.14	1.70	0.045	0.067
С	0.48	0.70	0.019	0.028
D	15.25	15.75	0.600	0.620
D1	1.27	typ.	0.050 typ.	
Е	10	10.40	0.394	0.409
е	2.4	2.7	0.094	0.106
e1	4.95	5.15	0.195	0.203
F	1.23	1.32	0.048	0.052
H1	6.20	6.60	0.244	0.260
J1	2.4	2.72	0.094	0.107
L	13.0	14.0	0.512	0.551
L1	3.5	3.93	0.138	0.155
L20	16.40 typ.		0.646 typ.	
L30	28.90 typ.		1.138 typ.	
θР	3.75	3.85	0.148	0.152
Q	2.65	2.95	0.104	0.116

## 2.4 TO-220FPAB package information

Figure 16: TO-220FPAB package outline

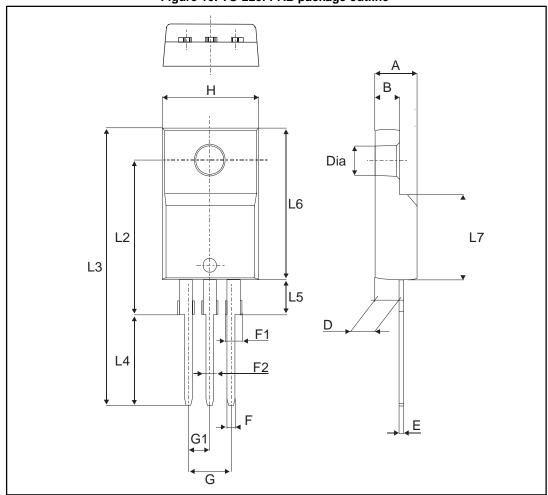


Table 9: TO-220FPAB package mechanical data

	Dimensions				
Ref.	Millin	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.173	0.181	
В	2.5	2.7	0.098	0.106	
D	2.50	2.75	0.098	0.108	
Е	0.45	0.70	0.018	0.027	
F	0.75	1.0	0.03	0.039	
F1	1.15	1.70	0.045	0.067	
F2	1.15	1.70	0.045	0.067	
G	4.95	5.20	0.195	0.205	
G1	2.40	2.70	0.094	0.106	
Н	10.00	10.40	0.393	0.409	
L2	16.00	0 typ.	0.63	typ.	
L3	28.60	30.60	1.126	1.205	
L4	9.80	10.6	0.386	0.417	
L5	2.90	3.60	0.114	0.142	
L6	15.90	16.40	0.626	0.646	
L7	9.00	9.30	0.354	0.366	
Dia	3.0	3.20	0.118	0.126	

STTH2002C Ordering information

## 3 Ordering information

**Table 10: Ordering information** 

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH2002CT	STTH2002CT	TO-220AB	1.9g	50	Tube
STTH2002CG	STTH2002CG	D <sup>2</sup> PAK	1.38g	50	Tube
STTH2002CG-TR	STTH2002CG	D <sup>2</sup> PAK	1.38g	1000	Tape and reel
STTH2002CR	STTH2002CR	I <sup>2</sup> PAK	1.5g	50	Tube
STTH2002CFP	STTH2002CFP	TO-220FPAB	1.9g	50	Tube

# 4 Revision history

**Table 11: Document revision history** 

Date	Revision	Changes
Feb-2004	1	First issue.
23-Jun-2010	2	Updated Table 1. Updated ECOPACK statement.
14-Dec-2015	3	Updated features, <i>Table 1: "Device summary"</i> and packages silhouette in cover page.  Updated <i>Section 1: "Characteristics"</i> and <i>Table 10: "Ordering information"</i> Updated <i>Section 2.2: "D2PAK package information"</i> .

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